

PRODUCT DATA SHEET METALLIQ SERIES

HIGH-PERFORMANCE LIQUID METAL COMPOUND

The METALLIQ series from Thermal Hero offers a state-of-the-art liquid metal compound made from gallium, indium and tin, which is extreme temperatures. This innovative combination achieves a perfect composition that makes it possible to minimize to fill the smallest gaps and unevenness of the surface by minimizing of the surface. This ensures fast and efficient efficient heat dissipation at high temperatures.

For users who demand the best cooling performance, the METALLIQ series is the ideal choice.

METALLIQ is a liquid metal compound with extremely high thermal conductivity and offers long-term stability even under extreme CPU and ambient temperatures. Even when the processor is under high workloads, METALLIQ ensures reliable cooling performance.



THERMAL HERO is a registered trademark.

PRODUCED IN GERMANY

| Technical Datas | |
|-----------------------------|----------------------|
| Unit | Value/description |
| SIZES | 1g 2g 5g |
| DENSITY | 6,4g/cm ³ |
| OPERATING TEMPERATURE* | -50 ~ 200 °C |
| MELTING TEMPERATURE** | 10 °C |
| APPLICATION TEMPERATURE *** | 10 ~ 120 °C |
| ELECTRICALLY CONDUCTIVE | yes |
| COLOR | silver |

*Recommended operating temperature range. **Temperature at which the compound changes from a solid to a liquid state.
***Recommended temperature range for optimal liquid metal application

| PROFILE |
|---|
| METALLIQ for EXTREME APPLICATIONS |
| USER CATEGORY: Extreme overclockers, high performance gamers, professional content creators, HPC researchers and developers, industrial engineers. |
| TYPE OF APPLICATION: Use in a high-performance server cluster or for scientific computing where maximum heat dissipation is required |
| TYPICAL APPLICATIONS: Extreme overclocking applications, high-performance computing (HPC), industrial applications, gaming consoles, laptops. |
| APPLICATION CLASS: High performance applications for advanced users. |

PROPERTIES

- EXTREMELY HIGH THERMAL CONDUCTIVITY
- VERY LOW THERMAL RESISTANCE
- LIQUID METAL BEST COOLING PERFORMANCE
- LONG-TERM STABILITY
- ELECTRICALLY CONDUCTIVE

| Logistical data | | | |
|-----------------|----------------|----------------------|-------------|
| SKU | EAN/UPC (GTIN) | weight net* /gross** | |
| TH-108001 | 4262483761083 | 1g (net) | 27g (gross) |
| TH-108002 | 4262483761090 | 2g (net) | 28g (gross) |
| TH-108005 | 4262483761106 | 5g (net) | 31g (gross) |

*NET WEIGHT: Item weight minus packaging and accessories.
**GROSS WEIGHT: Item weight incl. packaging and accessories.

| CAUTION during APPLICATION! |
|---|
| Take care when applying, as the gallium-indium-tin compound is electrically conductive! Avoid contact of METALLIQ with electrical components at all ! |
| Do not use METALLIQ on aluminum, aluminum/copper (DHT) or brass cooling plates, as it reacts chemically with these materials and can corrode them. |

| Product data | | | |
|-----------------|---------------------|-------|-------|
| Packaging dims. | 22x12x3cm (Einheit) | | |
| PU dimensions | 35x25x5cm | | |
| | 1g | 2g | 5g |
| Units per PU | 24pcs | 20pcs | 15pcs |
| PU Weight | 796g | 612g | 525g |

The information and technical specifications contained in these data sheets are based on tests under specified conditions and on our expertise and that of our partners. These specifications are snapshots and may vary depending on the conditions of use. As numerous factors can influence the performance of our products, the user is responsible for checking the suitability of the products for his specific requirements himself or having them checked by external third parties.

We reserve the right to make changes due to technical developments and printing errors. The user is also responsible for checking whether our recommendations for use may infringe the property rights of third parties.